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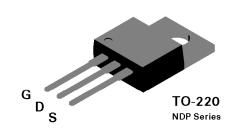
## NDP5060L / NDB5060L N-Channel Logic Level Enhancement Mode Field Effect Transistor

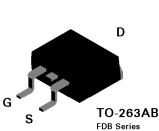
#### **General Description**

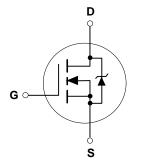
These logic level N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as automotive, DC/DC converters, PWM motor controls, and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

#### Features

- $\label{eq:alpha} \begin{array}{l} \bullet \quad 26 \text{ A, } 60 \text{ V. } \text{R}_{_{\text{DS(ON)}}} = 0.05 \ \Omega \ @ \ \text{V}_{_{\text{GS}}} = 5 \text{ V} \\ \text{R}_{_{\text{DS(ON)}}} = 0.035 \ \Omega \ @ \ \text{V}_{_{\text{GS}}} = 10 \text{ V.} \end{array}$
- Critical DC electrical parameters specified at elevated temperature.
- Rugged internal source-drain diode can eliminate the need for an external Zener diode transient suppressor.
- 175°C maximum junction temperature rating.
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- TO-220 and TO-263 (D<sup>2</sup>PAK) package for both through hole and surface mount applications.







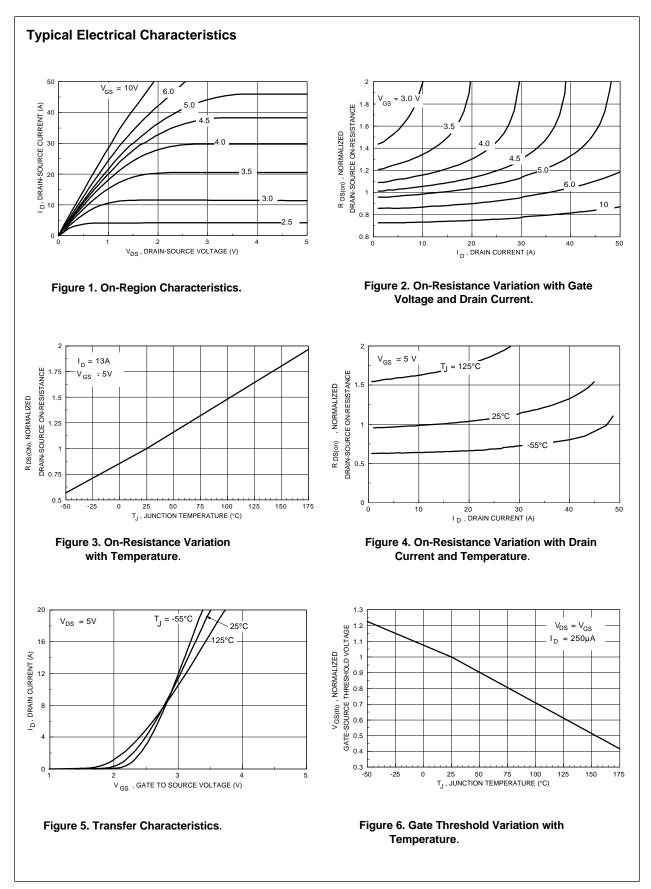
### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted

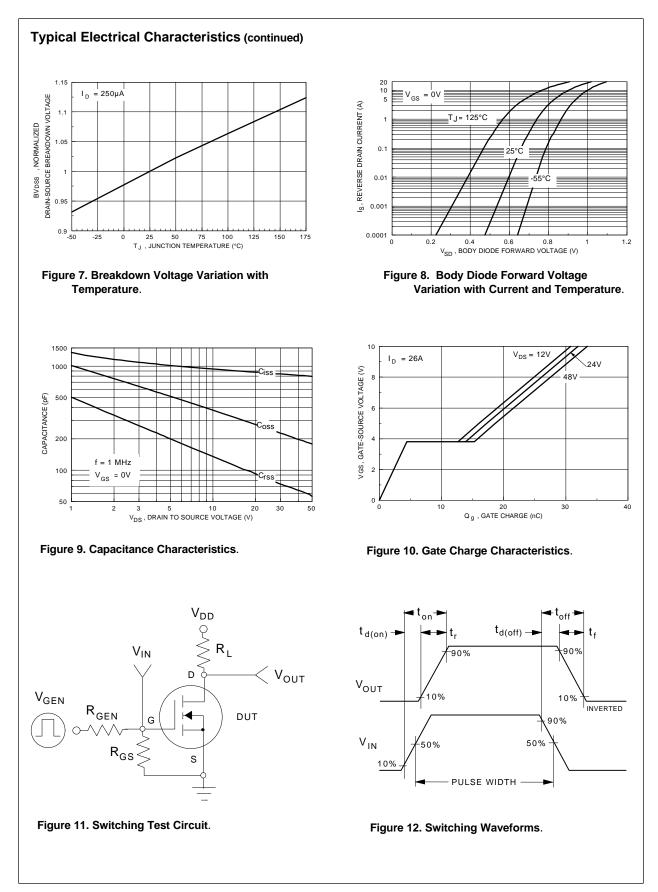
Symbol	Parameter	NDP5060L	NDB5060L	Units	
V <sub>DSS</sub>	Drain-Source Voltage	60		V	
$V_{\text{DGR}}$	Drain-Gate Voltage ( $R_{GS} \le 1 M\Omega$ )	60		V	
$V_{GSS}$	Gate-Source Voltage - Continuous	±16		V	
	- Nonrepetitive ( $t_p < 50 \ \mu s$ )	±25			
I <sub>D</sub>	Drain Current - Continuous 26		26	А	
	- Pulsed	78			
P <sub>D</sub>	Total Power Dissipation @ $T_c = 25^{\circ}C$	6	68		
	Derate above 25°C	0.	W/°C		
TJ,TSTG	Operating and Storage Temperature Range	-65 t	o 175	°C	

Symbol	Parameter	Conditions		Min	Тур	Max	Units
DRAIN-S	OURCE AVALANCHE RATINGS (Note 1)						
W <sub>DSS</sub>	Single Pulse Drain-Source Avalanche Energy	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 26 A				100	mJ
I <sub>AR</sub>	Maximum Drain-Source Avalanche Curre	ent				26	А
OFF CH/	ARACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		60			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{\rm DS} = 60 \text{ V}, V_{\rm GS} = 0 \text{ V}$				250	μA
			T <sub>J</sub> = 125°C			1	mA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	$V_{GS} = 16 \text{ V}, V_{DS} = 0 \text{ V}$	·			100	nA
I <sub>GSSR</sub>	Gate - Body Leakage, Reverse	$V_{GS} = -16 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				-100	nA
ON CHA	RACTERISTICS (Note 1)						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1	1.4	2	V
			T <sub>J</sub> = 125°C	0.65	1	1.5	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 5 \text{ V}, I_{D} = 13 \text{ A}$	·		0.042	0.05	Ω
			T <sub>J</sub> = 125°C		0.07	0.08	
		$V_{GS} = 10 \text{ V}, I_{D} = 13 \text{ A}$	·		0.031	0.035	ľ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 5 \text{ V}, V_{DS} = 10 \text{ V}$		26			А
9 <sub>FS</sub>	Forward Transconductance	$V_{\rm DS} = 10 \text{ V}, \text{ I}_{\rm D} = 13 \text{ A}$			16		S
DYNAMI	C CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			840		pF
C <sub>oss</sub>	Output Capacitance				230		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				75		pF
SWITCHI	NG CHARACTERISTICS (Note 1)						
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{DD} = 30 \text{ V}, \ I_{D} = 26 \text{ A}, \\V_{GS} = 5 \text{ V}, \ R_{GEN} = 30 \Omega \\R_{GS} = 30 \Omega$			13	20	nS
t,	Turn - On Rise Time				200	400	nS
t <sub>D(off)</sub>	Turn - Off Delay Time				45	80	nS
t <sub>f</sub>	Turn - Off Fall Time				102	200	nS
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = 24 V,$ $I_{D} = 26 A, V_{GS} = 5 V$			17	24	nC
Q <sub>gs</sub>	Gate-Source Charge				4		nC
Q <sub>gd</sub>	Gate-Drain Charge				10		nC

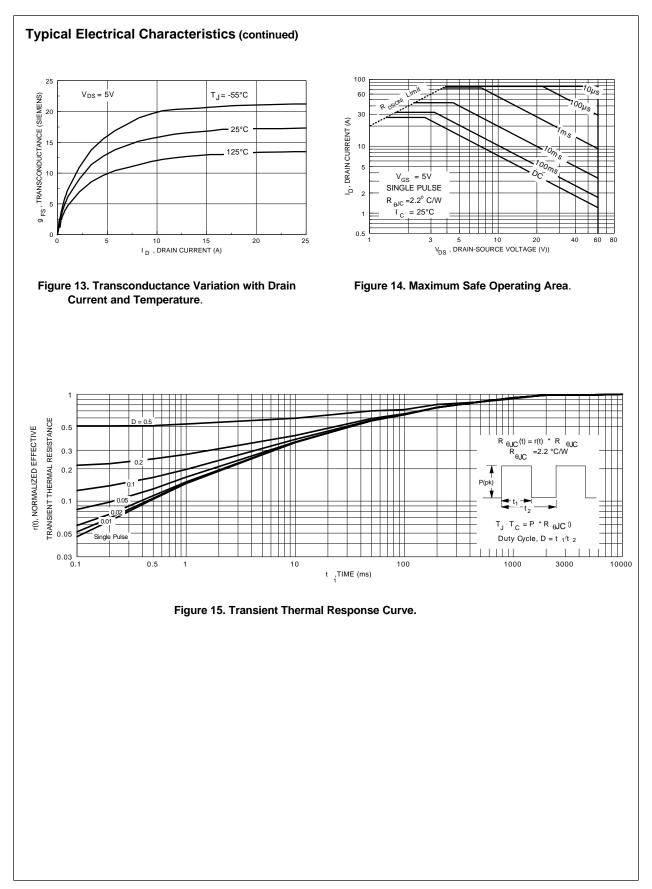
Electrical Characteristics (T <sub>c</sub> = 25°C unless otherwise noted)						
Symbol	Parameter	Conditions	Min	Тур	Max	Units
DRAIN-S	OURCE DIODE CHARACTERISTICS		•			
I <sub>s</sub>	Maximum Continuos Drain-Source Diode Forward Current				26	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				78	А
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 13 \text{ A} \text{ (Note 1)}$		0.9	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 V, I_F = 26 A,$ $dI_F/dt = 100 A/\mu s$		54	120	ns
l <sub>m</sub>	Reverse Recovery Current			2.1	8	Α
THERMA	L CHARACTERISTICS	· ·	÷		•	
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case				2.2	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient				62.5	°C/W

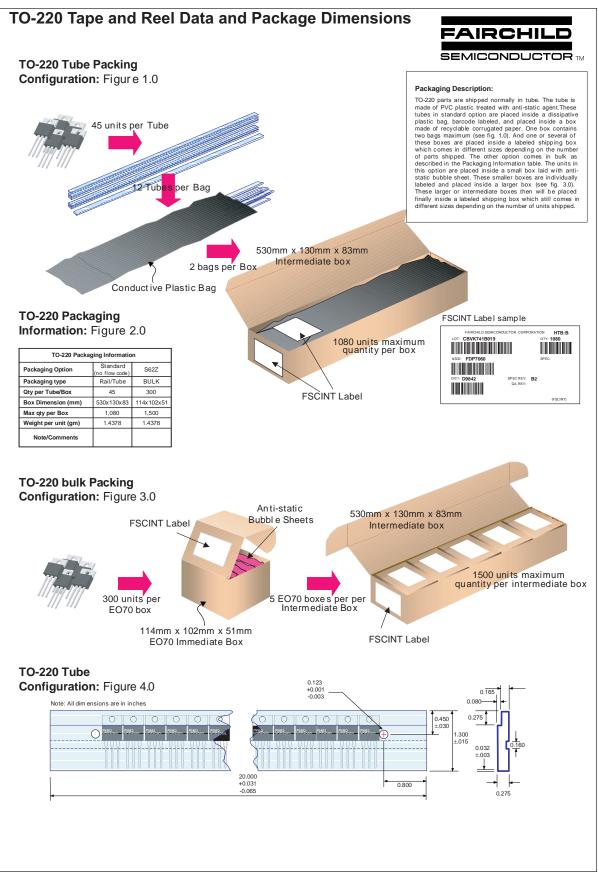
Note: 1. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2.0%.



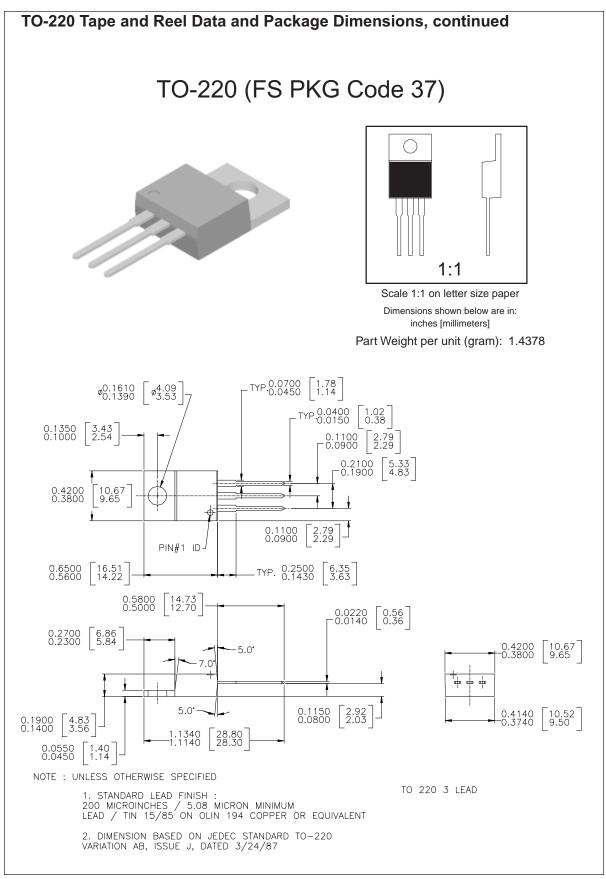


NDP5060L Rev.A

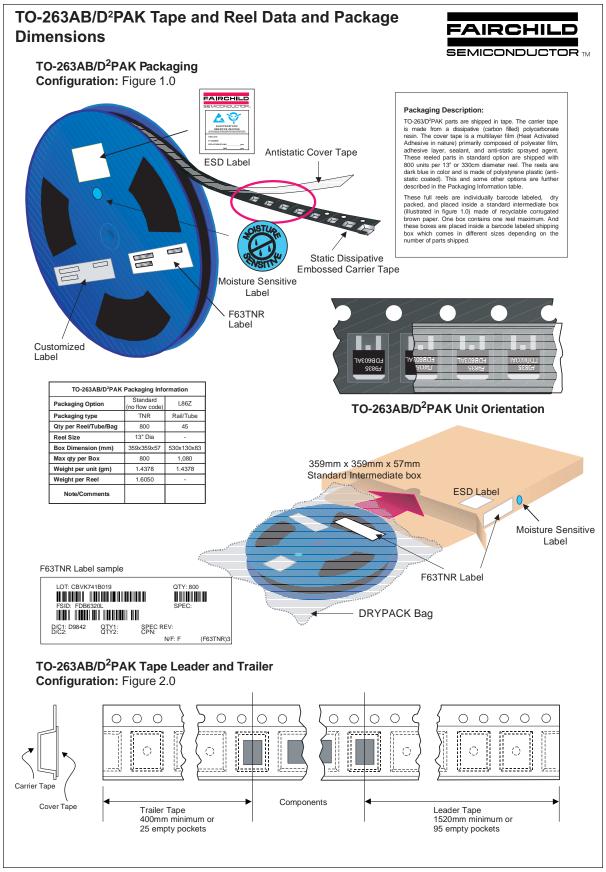




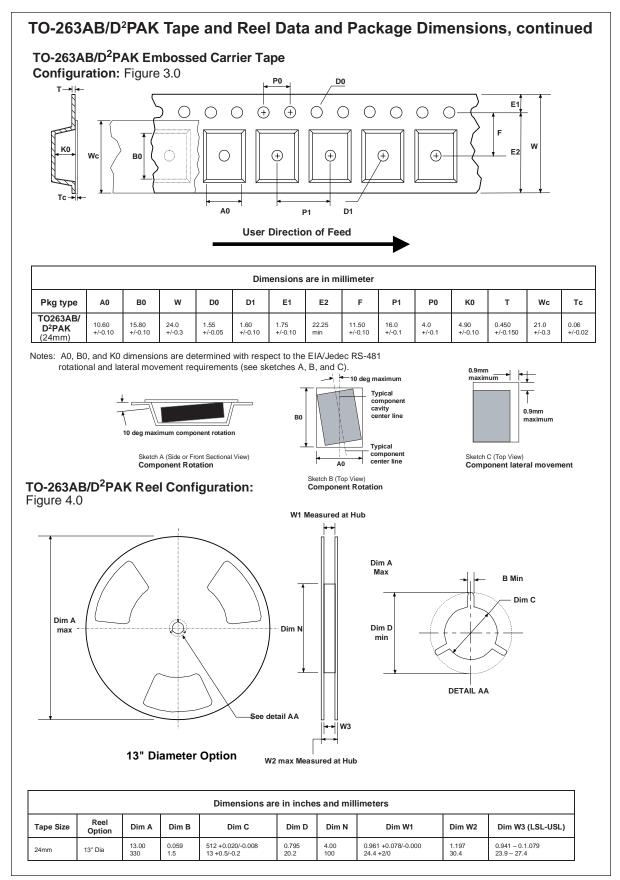
August 1999, Rev. B

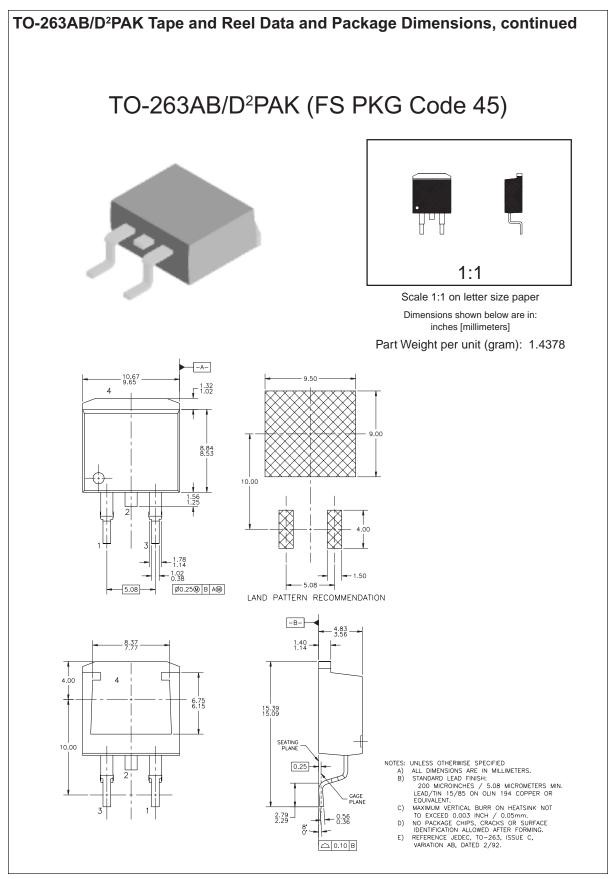


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